## **ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

Electronic Version v18

Stylesheet Version v18.0

## Title of Invention

Method and Apparatus for Using Connection Graphs with Potential Diagonal Edges to Model Interconnect Topologies During Placement

Application Number: 09/737245

Confirmation Number: 8353

First Named Applicant: Steven Teig, et al.

Attorney Docket Number: SPLX.P0012

Art Unit: 2825
Examiner: Thuan V Do

Search string: (4593363 or 4855929 or 5267176 or 5375069 or 5587923 or 5618744 or 5633479

or 5637920 or 5640327 or 5663891 or 5757089 or 5784289 or 5798936 or 5838583 or 5889677 or 5980093 or 6070108 or 6128767 or 6209123 or 6253363 or 6295634 or 6324674 or 6324675 or 6327693 or 6327694 or 6330707 or 6378121 or 6407434 or 6412102 or 6415422 or 6442743 or 6448591 or 6473891 or 6480991 or 6490713 or 6519751 or 6543043 or 6546540 or 6557145 or 6567967 or 6301686 or 6678872 or 6802049 or 20010009031 or 20020182844 or 20030005399 or 20030225205 or

20040123260 or 20030217346 or 20030014725 or 20040044979 or 20020133798

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Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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Signa	ture				
	Examiner N	Name		Date	